

*Customer:

SPECIFICATION

| | |
|--------------|-----------------------|
| ITEM | TOP LED DEVICE |
| MODEL | SSC-ERT801 |

www.DataSheet4U.com

[Contents]

| | | |
|------------------------------------|-------|---|
| 1. Features | ----- | 2 |
| 2. Application | ----- | 2 |
| 3. Absolute Maximum Ratings | ----- | 3 |
| 4. Electro-optical Characteristics | ----- | 3 |
| 5. Soldering Profile | ----- | 4 |
| 6. Outline Dimension | ----- | 5 |
| 7. Packing | ----- | 5 |
| 8. Reel Packing Structure | ----- | 6 |
| 9. Precaution for Use | ----- | 7 |
| 10. Characteristic Diagram | ----- | 8 |

| Drawn by | Checked by | Approved by |
|----------|------------|-------------|
| | | |
| | | |

1. Features

- White colored SMT package and colorless clear window
- Material : AlGaInP
- Suitable for all SMT assembly methods ; Suitable for all soldering methods

2. Application

- Automotive
- Electric appliance
- Lightings

www.DataSheet4U.com

3. Absolute Maximum Ratings ^{*1}

($T_a=25^{\circ}\text{C}$)

| Parameter | Symbol | Value | Unit |
|-----------------------|------------------------|------------|--------------------|
| Power Dissipation | P_d | 80 | mW |
| Forward Current | I_F | 30 | mA |
| Peak Forward Current | I_{FM} ^{*2} | 90 | mA |
| Reverse Voltage | V_R | 5 | V |
| Operating Temperature | T_{opr} | -40 ~ +100 | $^{\circ}\text{C}$ |
| Storage Temperature | T_{stg} | -40 ~ +100 | $^{\circ}\text{C}$ |

*1 Care is to be taken that power dissipation does not exceed the absolute maximum rating of the product.

*2 I_{FM} was measured at $T_w \leq 0.1\text{msec}$ of pulse width and $D \leq 1/10$ of duty ratio.

4. Electro-Optical Characteristics

($T_a=25^{\circ}\text{C}$)

| Parameter | Symbol | Condition | Min | Typ | Max | Unit |
|-----------------------------------|-----------------|-------------------|-----|-----|-----|---------------|
| Forward Voltage | V_F | $I_F=20\text{mA}$ | 1.7 | 2.0 | 2.3 | V |
| Reverse Current | I_R | $V_R=5\text{V}$ | - | - | 10 | μA |
| Luminance Intensity ^{*1} | I_V | $I_F=20\text{mA}$ | 50 | 90 | 130 | mcd |
| Peak Wavelength | λ_p | $I_F=20\text{mA}$ | - | 650 | - | nm |
| Dominant Wavelength | λ_d | $I_F=20\text{mA}$ | 630 | 635 | 640 | nm |
| Spectral Bandwidth 50% | $\Delta\lambda$ | $I_F=20\text{mA}$ | - | 18 | - | nm |
| Viewing Angle ^{*2} | $2\theta_{1/2}$ | $I_F=20\text{mA}$ | - | 120 | - | deg. |

*1 The luminous intensity I_V was measured at the peak of the spatial pattern which may not be aligned with the mechanical axis of the LED package. Luminous Intensity Measurement allowance is $\pm 10\%$.

*2 $2\theta_{1/2}$ was the off-axis where the luminous intensity is 1/2 of the peak intensity.

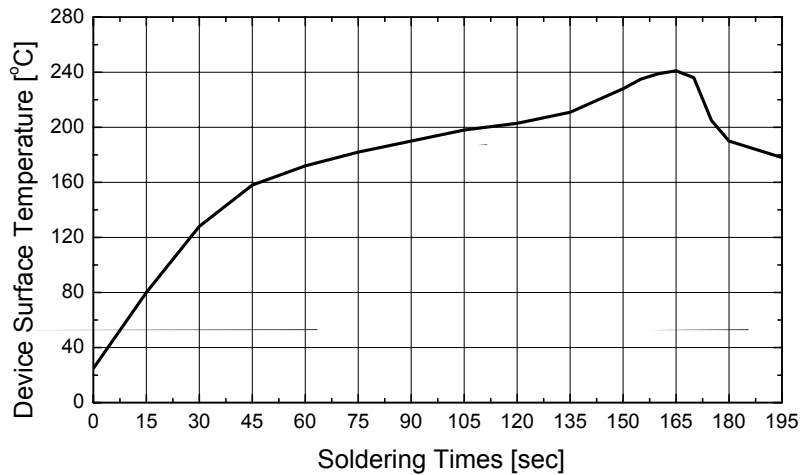
[Note] All measurements were made under the standardized environment of SSC

5. Soldering Profile

(1) Reflow Soldering Conditions / Profile

Preliminary heat to be at maximum 150°C for maximum 2 minutes.

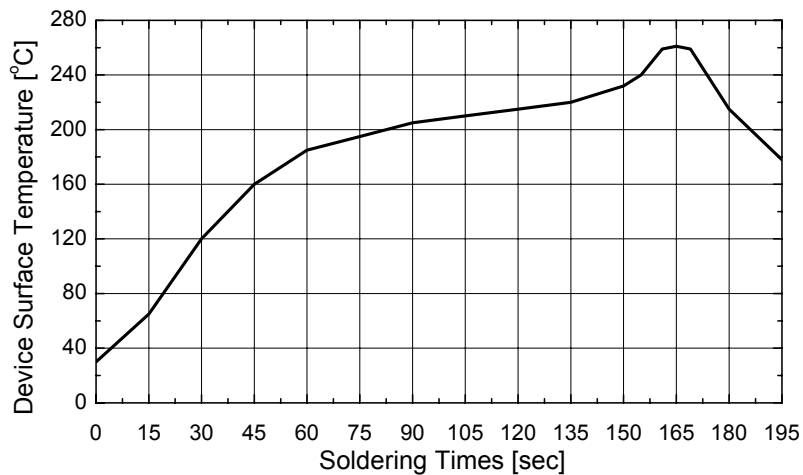
Soldering heat to be at maximum 240°C for maximum 10 seconds.



(2) Lead-free solder

Preliminary heating to be at maximum 220°C for maximum 2 minutes.

Soldering heat to be at maximum 260°C for maximum 10 seconds.

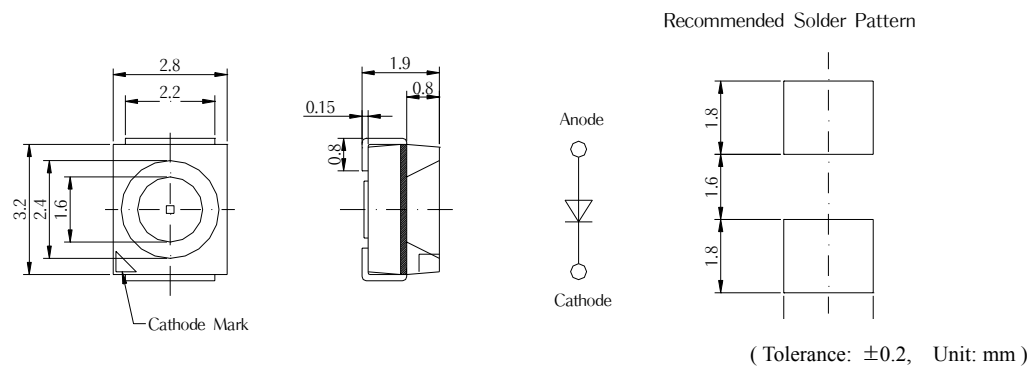


(3) Hand Soldering conditions

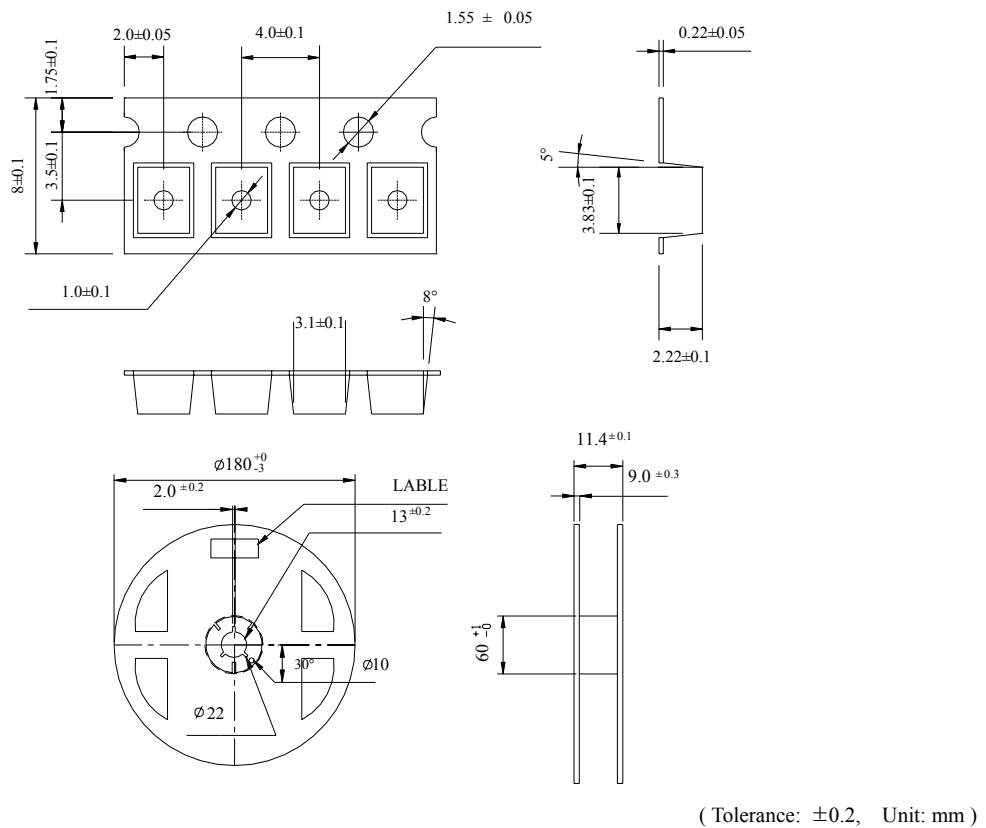
Do not exceed 3 seconds at maximum 300°C under soldering iron.

Note : In case that the soldered products are reused in soldering process, we don't guarantee the products.

6. Outline Dimension



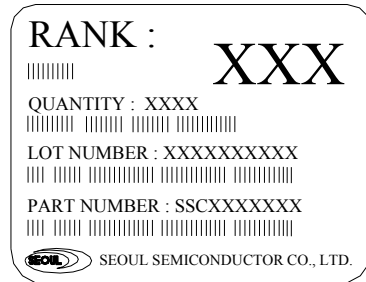
7. Packing



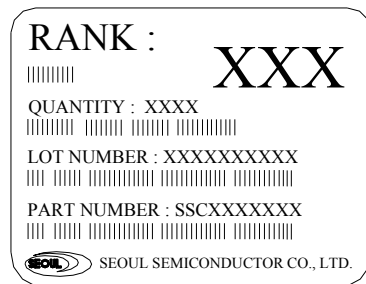
- (1) Quantity : 2000pcs/Reel
- (2) Cumulative Tolerance : Cumulative Tolerance/10 pitches to be $\pm 0.2\text{mm}$
- (3) Adhesion Strength of Cover Tape : Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape
- (4) Package : P/N, Manufacturing data Code No. and quantity to be indicated on a damp proof Package

8. Reel Packing Structure

Reel



Aluminum Vinyl Bag

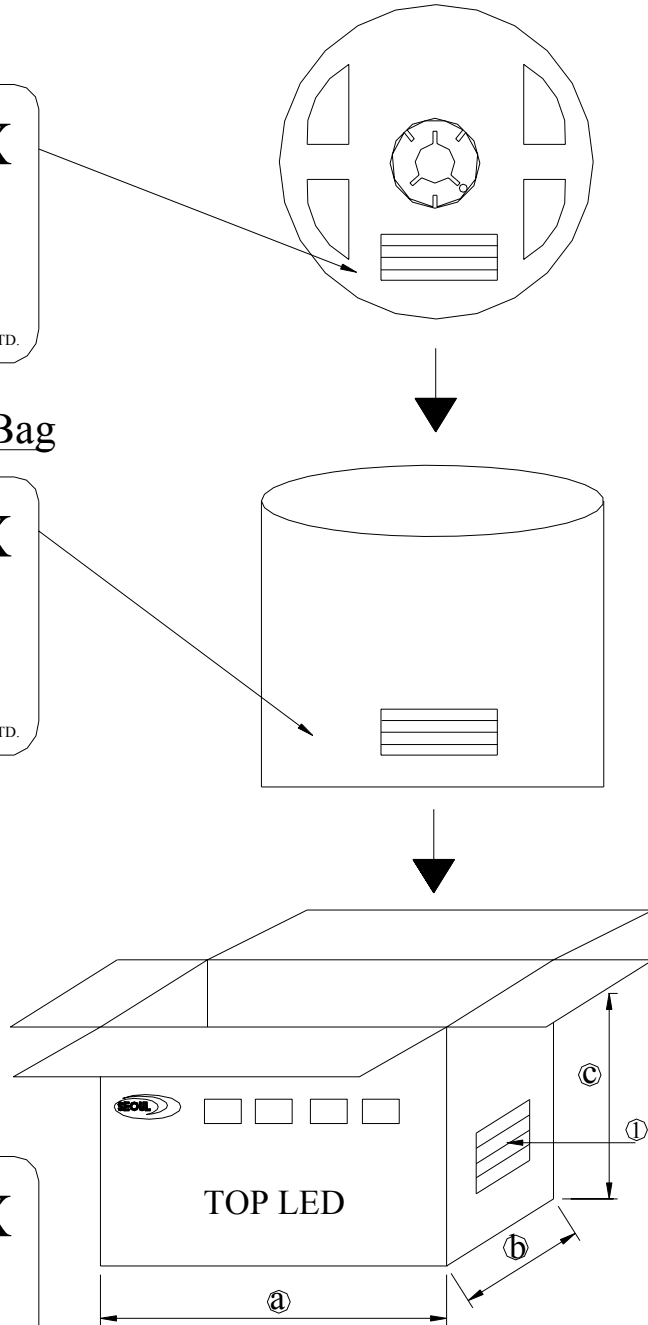
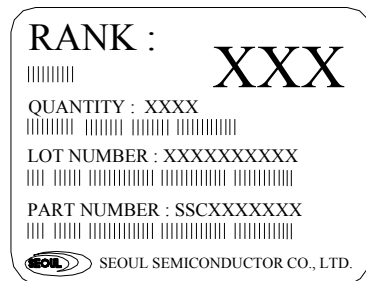


Outer Box Structure

Material : Paper(SW3B(B))

| TYPE | SIZE (mm) | | |
|-------|-----------|-----|-----|
| | a | b | c |
| 7inch | 245 | 220 | 142 |

① SIDE



9. Precaution for use

(1) Storage

In order to avoid the absorption of moisture, it is recommended to store in a dry box (or a desiccator) with a desiccant. Otherwise, to store them in the following environment is recommended.

Temperature : 5°C ~30°C Humidity : maximum 60%HR

* The LED is classified to Class 3 by JEDEC (J-STD-020A and J-STD-033).

(2) Attention after open.

LED is correspond to SMD, when LED be soldered dip, interfacial separation may affect the light transmission efficiency, causing the light intensity to drop. Attention in followed;

- a. After opened and mounted the soldering shall be quickly.
- b. Keeping of a fraction

Temperature : 5 ~ 40°C Humidity : less than 30%

(3) In the case of more than 1 week passed after opening or change color of indicator on desiccant, components shall be dried 10-12hr. at 60±5°C.

(4) In the case of that the components is humided, the components shall be dried;

24Hr at 80±5°C or 12Hr at 100±5°C.

(5) Any mechanical force or any excess vibration shall not be accepted to apply during cooling process to normal temperature after soldering.

(6) Quick cooling shall be avoided.

(7) Components shall not be mounted on warped direction of L/F.

(8) Anti radioactive ray design is not considered for the products.

(9) This device should not be used in any type of fluid such as water, oil, organic solvent etc. When washing is required, IPA should be used.

(10) When the LEDs are illuminating, operating current should be decided after considering the ambient maximum temperature.

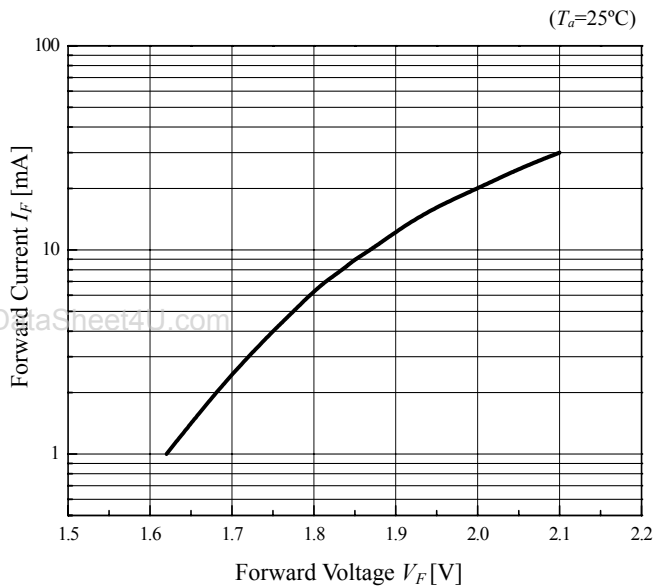
(11) LEDs must be stored to maintain a clean atmosphere. If the LEDs are stored for 3 months or more after being shipped from SSC, a sealed container with a nitrogen atmosphere should be used for storage.

(12) The LEDs must be soldered within seven days after opening the moisture-proof packing.

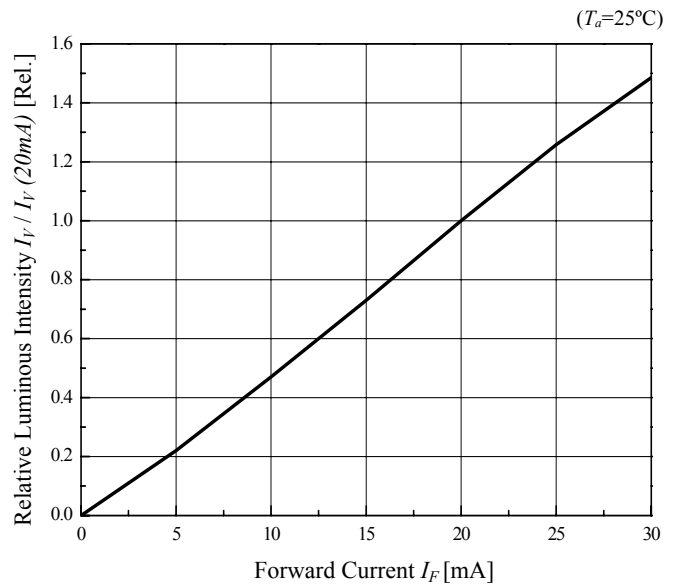
(13) Repack unused products with anti-moisture packing, fold to close any opening and then store in a dry place.

10. Characteristic Diagram

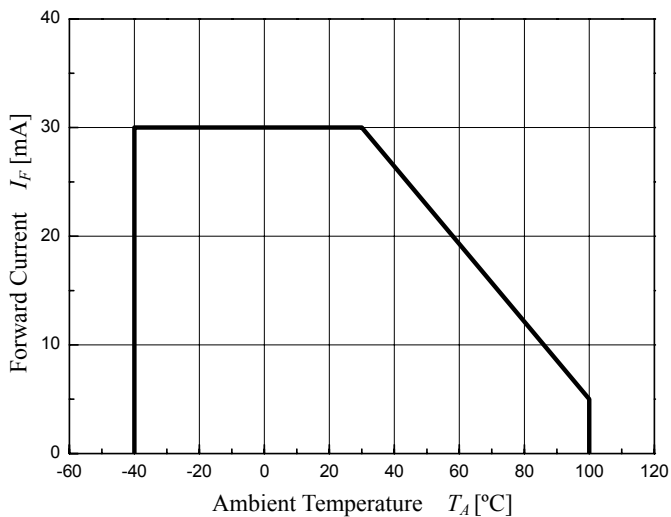
Forward Current vs. Forward Voltage



Relative Luminous Intensity vs. Forward Current



Forward Current Derating Curve



Radiation Diagram

